

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	4107	semiconductor and ((active or circuit) near5 (area or region or portion)) and ((wir\$3 near5 (area or region or portion)) same (peripher\$3 or edge or outside)) and (chip or die or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 00:19
S15	3050	semiconductor and ((active or circuit) near5 (area or region or portion)) and ((wir\$3 near5 (area or region or portion)) with (peripher\$3 or edge or outside)) and (chip or die or substrate)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 00:19
S16	2430	semiconductor and ((active or circuit) near5 (area or region or portion)) and ((wir\$3 near5 (area or region or portion)) with (peripher\$3 or edge or outside)) and (chip or die or substrate) and @ad<"20021230"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 00:20
S18	16	semiconductor and ((active or circuit) near5 (area or region or portion)) and ((wir\$3 near5 (area or region or portion)) with (peripher\$3 or edge or outside)) and (chip or die or substrate) and @ad<"20021230" and (redistribut\$5 with wir\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 00:23
S19	136	semiconductor and ((active or circuit) near5 (area or region or portion)) and @ad<"20021230" and (redistribut\$5 with wir\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 00:32
S17	16	semiconductor and ((active or circuit) near5 (area or region or portion)) and ((wir\$3 near5 (area or region or portion)) with (peripher\$3 or edge or outside)) and (chip or die or substrate) and @ad<"20021230" and (redistribut\$5 with wir\$3)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 00:35
S21	1584	semiconductor and ((active or circuit) near5 (area or region or portion)) and ((wir\$3 near5 (area or region or portion)) with (peripher\$3 or edge or outside)) and (chip or die or substrate) and @ad<"20021230" and (passive or capacit\$4 or induct\$4)	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 00:36

S22	385	semiconductor and ((active or circuit) near5 (area or region or portion)) and (((wir\$3 near5 (area or region or portion)) with (peripher\$3 or edge or outside)) same (passive or capacit\$4 or induct\$4)) and (chip or die or substrate) and @ad<"20021230"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 01:10
S23	1589	(257/692).ccls. and @ad<"20021230"	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 01:11
S24	195	(257/692).ccls. and @ad<"20021230" and ((redistribut\$ or passive or induct\$4 or capacit\$4) with (wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 01:22
S25	214	(257/773).ccls. and @ad<"20021230" and ((redistribut\$ or passive or induct\$4 or capacit\$4) with (wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 01:32
S26	179	(257/786).ccls. and @ad<"20021230" and ((redistribut\$ or passive or induct\$4 or capacit\$4) with (wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 05:42
S27	89	(257/528).ccls. and @ad<"20021230" and ((redistribut\$ or passive or induct\$4 or capacit\$4) with (wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 06:12
S28	573	(257/531 or 257/532).ccls. and @ad<"20021230" and ((redistribut\$ or passive or induct\$4 or capacit\$4) with (wir\$4))	US-PGPUB; USPAT; EPO; JPO; DERWENT	OR	ON	2005/05/27 06:13